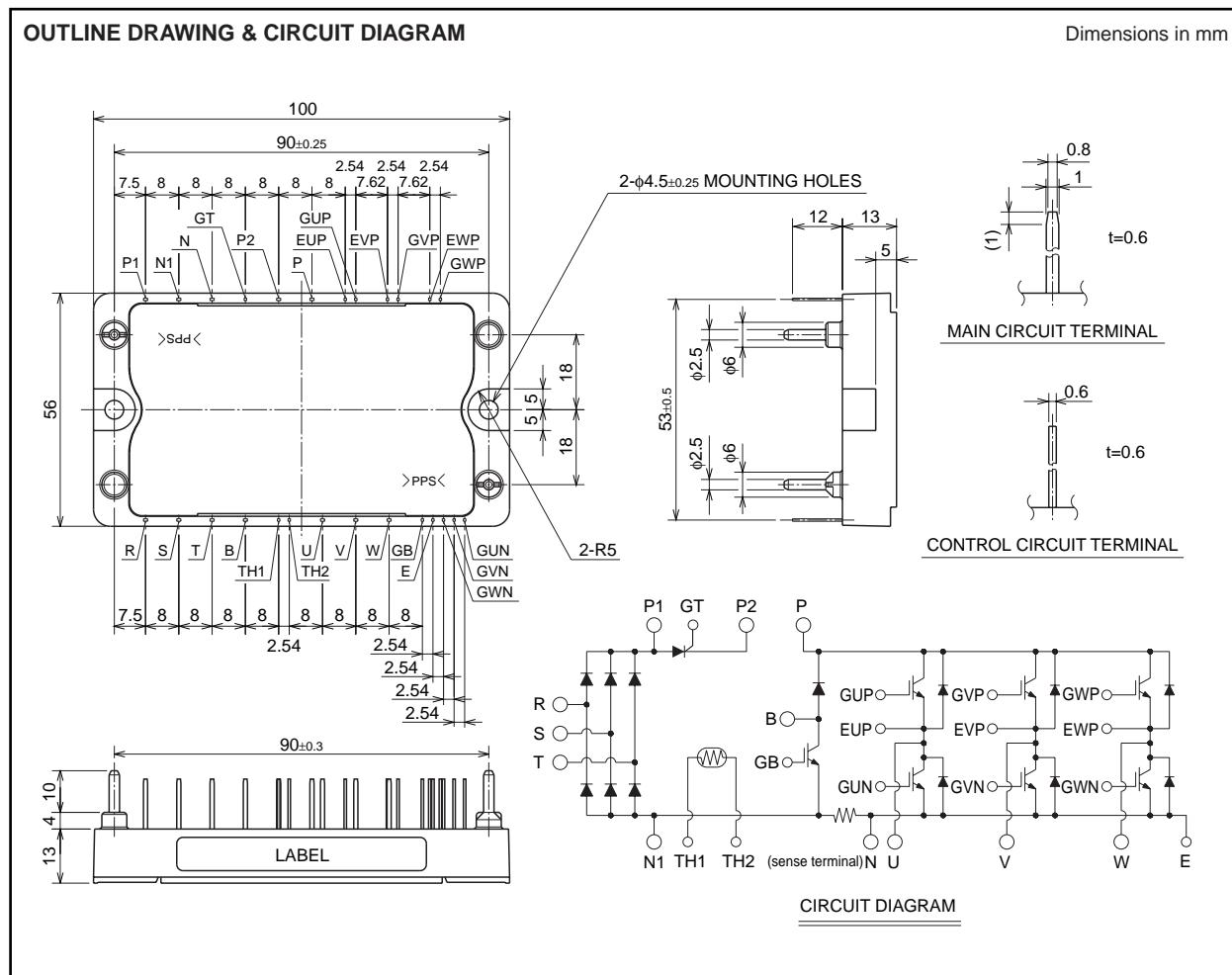


CM20AD00-12HMEDIUM POWER SWITCHING USE
FLAT BASE, INSULATED TYPE**CM20AD00-12H**

- IC 20A
 - VCES 600V
 - Insulated Type
 - CIB Module
- 3φ Inverter + 3φ Converter + Brake
Thyristor + Thermistor + Current shunt
resistor

APPLICATION

AC & DC motor controls, General purpose inverters



MAXIMUM RATINGS (T_J = 25°C)
INVERTER PART

Symbol	Parameter	Conditions	Rating	Unit
V _{CES}	Collector-emitter voltage	G-E Short	600	V
V _{GES}	Gate-emitter voltage	C-E Short	±20	V
I _C	Collector Current	T _C = 25°C	20	A
I _{CM}		PULSE (Note. 2)	40	A
I _E (Note.1)	Emitter Current	T _C = 25°C	20	A
I _{EM} (Note.1)		PULSE (Note. 2)	40	A
P _C (Note.3)	Maximum collector dissipation	T _C = 25°C	62	W

BRAKE PART

Symbol	Parameter	Conditions	Rating	Unit
V _{CES}	Collector-emitter voltage	G-E Short	600	V
V _{GES}	Gate-emitter voltage	C-E Short	±20	V
I _C	Collector Current	T _C = 25°C	20	A
I _{CM}		PULSE (Note. 2)	40	A
P _C (Note.3)	Maximum collector dissipation	T _C = 25°C	59	W
V _{RMM}	Repetitive peak reverse voltage	Clamp diode part	600	V
I _{FM} (Note.3)	Forward current	Clamp diode part	20	A

CONVERTER PART

Symbol	Parameter	Conditions	Rating	Unit
V _{RMM}	Repetitive peak reverse voltage		800	V
E _a	Recommended AC input voltage		220	V
I _O	DC output current	3φ rectifying circuit	20	A
I _{FSM}	Surge (non-repetitive) forward current	1/2 cycle at 60Hz, peak value, Non-repetitive	200	A
I ² t	I ² t for fusing	Value for one cycle of surge current	165	A ² s

THYRISTOR PART

Symbol	Parameter	Conditions	Rating	Unit
V _{DRM}	Repetitive peak off-state voltage		800	V
V _{RMM}	Repetitive peak reverse voltage		800	V
I _{T(AV)}	Average on-state current	Single-phase, half-wave 180° conduction	20	A
I _{TS} M	Surge (non-repetitive) on-state current	1/2 cycle at 60Hz, peak value Non-repetitive	200	A
P _{GM}	Peak gate power dissipation		10	W
P _{G(AV)}	Average gate power dissipation		1	W
I _{FGM}	Peak gate forward current		3	A
V _{FGM}	Peak gate forward voltage		10	V
V _{RGM}	Peak gate reverse voltage		5	V
dI/dt	Critical rate of rise of on-state Current	I _G =100mA, V _D =400V, dI _G /dt=1A/μs	100	A/μs

COMMON RATING

Symbol	Parameter	Conditions	Rating	Unit
T _j	Junction temperature	Inverter, brake, converter part	-40 ~ +150	°C
T _j	Junction temperature	Thyristor part	-40 ~ +125	°C
T _{stg}	Storage temperature		-40 ~ +125	°C
V _{iso}	Isolation voltage	AC 1 min.	2500	V
—	Mounting torque	Mounting M4 screw	1.47 ~ 1.96	N·m
—	Weight	Typical value	120	g

ELECTRICAL CHARACTERISTICS ($T_j = 25^\circ\text{C}$)
INVERTER PART

Symbol	Parameter	Test conditions	Limits			Unit		
			Min.	Typ.	Max.			
I_{CES}	Collector cutoff current	$V_{CE} = V_{CES}$, $V_{GE} = 0V$	—	—	1	mA		
$V_{GE(\text{th})}$	Gate-emitter threshold voltage	$I_C = 2.0\text{mA}$, $V_{CE} = 10V$	4.5	6	7.5	V		
I_{GES}	Gate-emitter cutoff current	$V_{GE} = V_{GES}$, $V_{CE} = 0V$	—	—	0.5	μA		
$V_{CE(\text{sat})}$	Collector-emitter saturation voltage	$T_j = 25^\circ\text{C}$	$I_C = 20\text{A}$, $V_{GE} = 15V$	(Note.4)	—	2.1	2.8	V
		$T_j = 150^\circ\text{C}$			—	2.15	—	
C_{IES}	Input capacitance	$V_{CE} = 10V$ $V_{GE} = 0V$	—	—	2.0	nF		
C_{OES}	Output capacitance		—	—	1.5	nF		
C_{RES}	Reverse transfer capacitance		—	—	0.4	nF		
Q_G	Total gate charge	$V_{CC} = 300V$, $I_C = 20A$, $V_{GE} = 15V$	—	60	—	nC		
$t_{d(on)}$	Turn-on delay time	$V_{CC} = 300V$, $I_C = 20A$	—	—	120	ns		
t_r	Turn-on rise time	$V_{GE1} = V_{GE2} = 15V$	—	—	300	ns		
$t_{d(off)}$	Turn-off delay time	$R_G = 31\Omega$	—	—	200	ns		
t_f	Turn-off fall time	Resistive load	—	—	300	ns		
$V_{EC(\text{Note.1})}$	Emitter-collector voltage	$I_E = 20A$, $V_{GE} = 0V$	—	—	2.8	V		
$t_{rr (\text{Note.1})}$	Reverse recovery time	$I_E = 20A$, $V_{GE} = 0V$	—	—	110	ns		
$Q_{rr (\text{Note.1})}$	Reverse recovery charge	$dI_E / dt = -40A / \mu\text{s}$	—	0.05	—	μC		
$R_{th(j-c)Q}$	Thermal resistance	IGBT part, Per 1/6 module	—	—	2.0	°C/W		
$R_{th(j-c)R}$		FWDI part, Per 1/6 module	—	—	3.1	°C/W		

BRAKE PART

Symbol	Parameter	Test conditions	Limits			Unit		
			Min.	Typ.	Max.			
I_{CES}	Collector cutoff current	$V_{CE} = V_{CES}$, $V_{GE} = 0V$	—	—	1	mA		
$V_{GE(\text{th})}$	Gate-emitter threshold voltage	$I_C = 2.0\text{mA}$, $V_{CE} = 10V$	4.5	6	7.5	V		
I_{GES}	Gate-emitter cutoff current	$V_{GE} = V_{GES}$, $V_{CE} = 0V$	—	—	0.5	μA		
$V_{CE(\text{sat})}$	Collector-emitter saturation voltage	$T_j = 25^\circ\text{C}$	$I_C = 20\text{A}$, $V_{GE} = 15V$	(Note.4)	—	2.1	2.8	V
		$T_j = 150^\circ\text{C}$			—	2.15	—	
C_{IES}	Input capacitance	$V_{CE} = 10V$ $V_{GE} = 0V$	—	—	2.0	nF		
C_{OES}	Output capacitance		—	—	1.5	nF		
C_{RES}	Reverse transfer capacitance		—	—	0.4	nF		
Q_G	Total gate charge	$V_{CC} = 300V$, $I_C = 20A$, $V_{GE} = 15V$	—	60	—	nC		
V_{FM}	Forward voltage drop	$I_F = 20A$, Clamp diode part	—	—	2.8	V		
$R_{th(j-c)Q}$	Thermal resistance	IGBT part	—	—	2.1	°C/W		
$R_{th(j-c)R}$		Clamp diode part	—	—	3.2	°C/W		

CONVERTER PART

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
I_{RRM}	Repetitive reverse current	$VR = V_{RRM}$, $T_j = 150^\circ\text{C}$	—	—	8	mA
V_{FM}	Forward voltage drop	$I_F = 20A$	—	—	1.5	V
$R_{th(j-c)}$	Thermal resistance	Per 1/6 module	—	—	3.1	°C/W

THYRISTOR PART

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
IDRM	Repetitive peak off-state current	VD=800V	—	—	1	mA
IRRM	Repetitive peak reverse current	VR=800V	—	—	1	mA
ITM	On-state voltage	IT=20A, instantaneous means	—	—	1.55	V
IGT	Gate trigger current	VD=6V, IT=1A	—	—	50	mA
VGT	Gate trigger voltage	VD=6V, IT=1A	—	—	3	V
dv/dt	Critical rate of rise of off-state Voltage	T _j =125°C, VD=540V, exp. waveform	500	—	—	V/μs
IH	Holding current		—	50	—	mA
R _{th(j-c)}	Thermal resistance		—	—	1.75	°C/W

THERMISTOR PART

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
R _{th}	Resistance	T _c = 25°C	—	100	—	kΩ
B	B Constant	Resistance at 25°C, 50°C (Note.5)	—	4000	—	K

RESISTOR PART

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
R	Resistance	Measured between N-N1	—	3.4	—	mΩ
—	Temperature coefficient		—	0.079	—	%/°C

COMMON RATING

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
R _{th(c-f)}	Contact thermal resistance	Case to fin, Thermal compound applied*1 (1 module)	—	0.05	—	°C/W

Note.1 IE, VEC, tr_r, Q_{rr}, diE/dt represent characteristics of the anti-parallel, emitter to collector free-wheel diode.2 Pulse width and repetition rate should be such that the device junction temp. (T_j) does not exceed T_{jmax} rating.3 Junction temperature (T_j) should not increase beyond 150°C.

4 Pulse width and repetition rate should be such as to cause negligible temperature rise.

5 B = (lnR₁-lnR₂)/(1/T₁-1/T₂) R₁ : Resistance at T₁(K)R₂ : Resistance at T₂(K)

*1 : Typical value is measured by using Shin-etsu Silicone "G-746".